



## Features

- Average Forward Current:  $I_{F(AV)}=2A$
- Polarity: Color band denotes cathode



## Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
ES2AB-ES2JB	SMB (DO-214AA)	ES2x	3000

x: From A-J

SMB  
(DO-214AA)



## Maximum Ratings (Ta=25 unless otherwise noted)

Item	Symbol	Unit	Test Conditions	ES2							
				AB	BB	CB	DB	EB	GB	HB	JB
Repetitive Peak Reverse Voltage	$V_{RRM}$	V		50	100	150	200	300	400	500	600
Maximum RMS Voltage	$V_{RMS}$	V		35	70	105	140	210	280	350	420
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave, Resistance load, Ta=110 °C	2.0							
Surge(Non-repetitive)Forward Current	$I_{FSM}$	A	60Hz Half-sine wave, 1 cycle, Ta=25 °C	50							
Operation Junction and Storage Temperature Range	$T_J, T_{STG}$	°C		-55 ~ +150							

## Electrcal Charcteristics (Ta=25 unless otherwise specified)

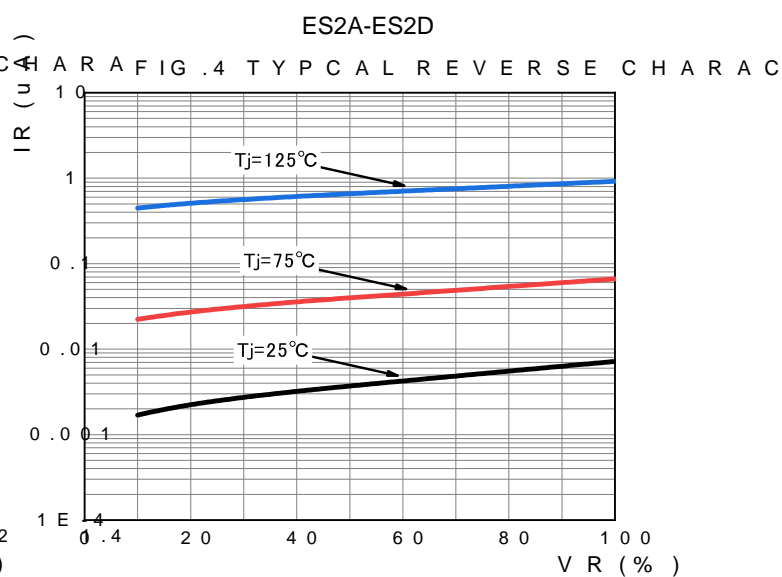
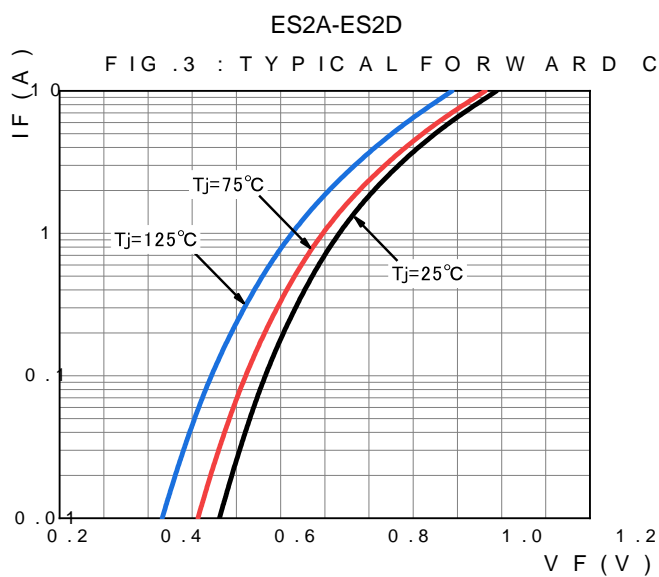
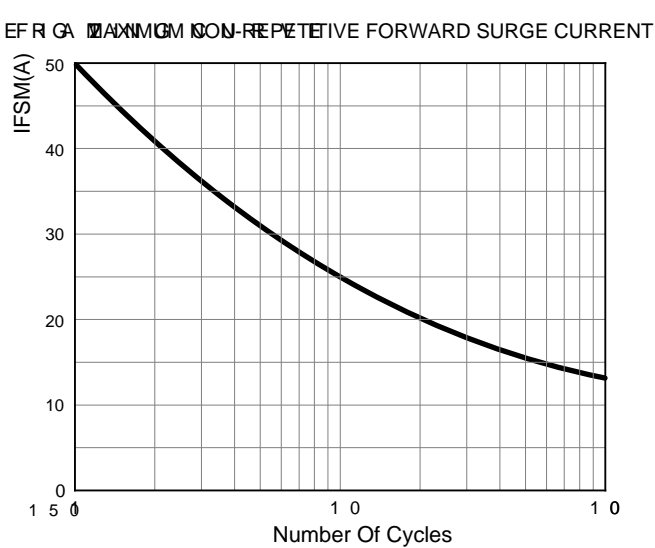
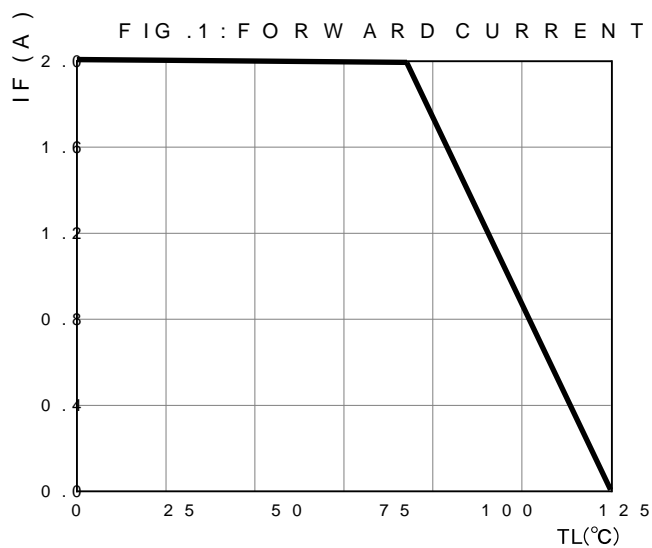
Item	Symbol	Unit	Test Condition		ES2							
					AB	BB	CB	DB	EB	GB	HB	JB
Peak Forward Voltage	V <sub>F</sub>	V	I <sub>F</sub> =2.0A		0.95			1.25		1.7		
Maximum reverse recovery time	t <sub>rr</sub>	ns	I <sub>F</sub> =0.5A,I <sub>R</sub> =1.0A,I <sub>rr</sub> =0.25A		35							
Peak Reverse Current	I <sub>RRM1</sub>	μA	V <sub>RM</sub> =V <sub>RRM</sub>	T <sub>a</sub> =25℃	5.0							
	T <sub>a</sub> =125℃			50								
Thermal Resistance(Typical)	R <sub>θJ-A</sub>	℃/W	Between junction and ambient		65							
	R <sub>θJ-L</sub>		Between junction and terminal		18							
Juction Capacitance (Typical)	Cj	pF	Measured at 1MHZ and Applied Reverse Voltage of 4.0 V.D.C		26			20				

### Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.27" x 0.27" (7.0 mm x 7.0 mm) copper pad areas



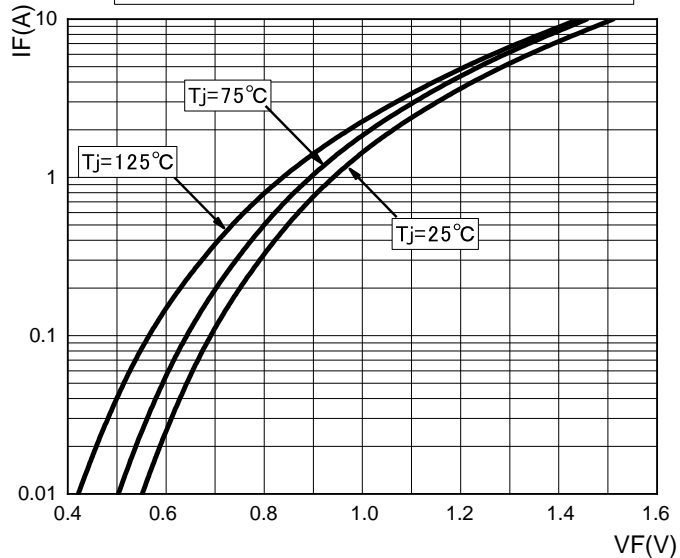
## Typical Characteristics





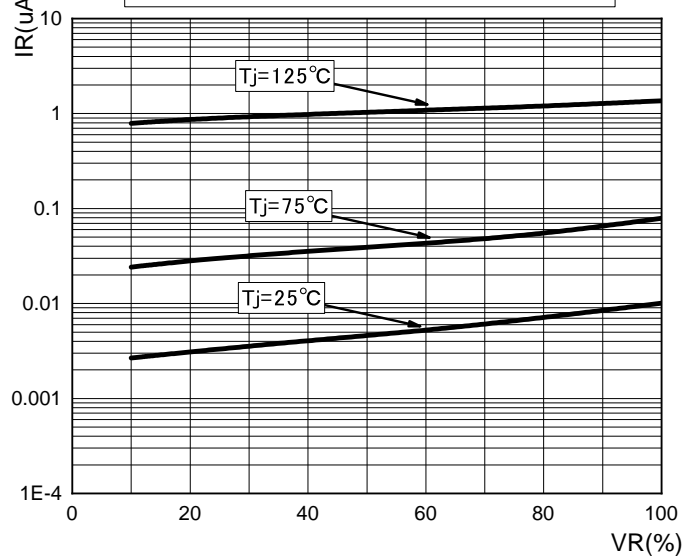
ES2EB-ES2GB

FIG.5 : TYPICAL FORWARD CHARACTERISTICS



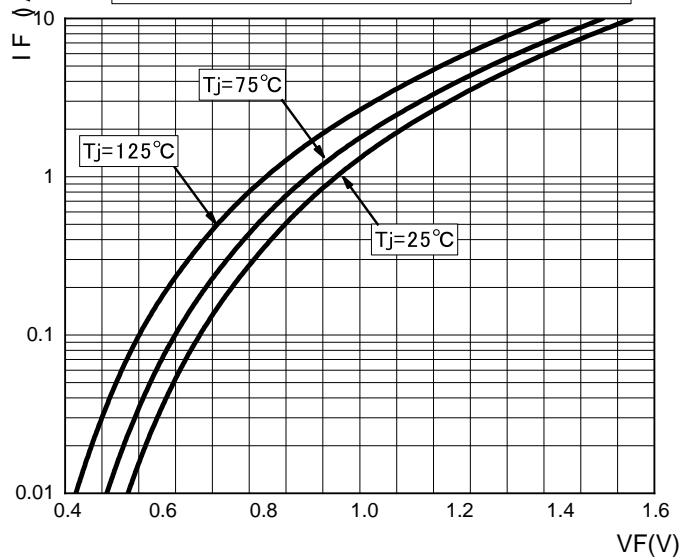
ES2EB-ES2GB

FIG.6 TYPICAL REVERSE CHARACTERISTICS



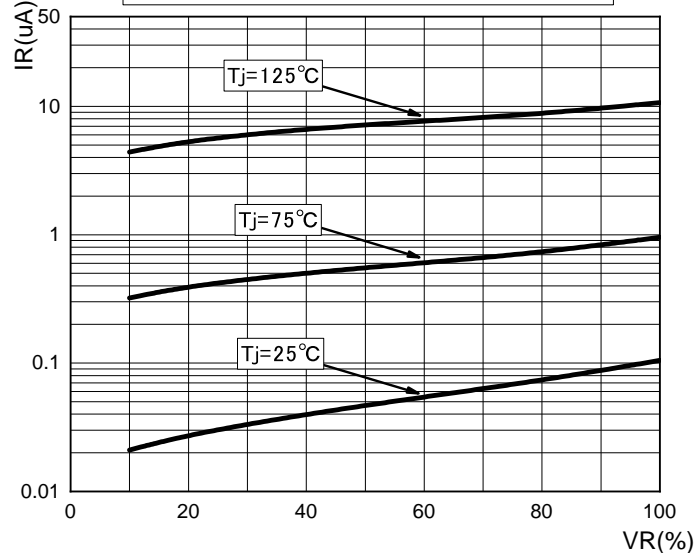
ES2HB-ES2JB

FIG.7 : TYPICAL FORWARD CHARACTERISTICS



ES2HB-ES2JB

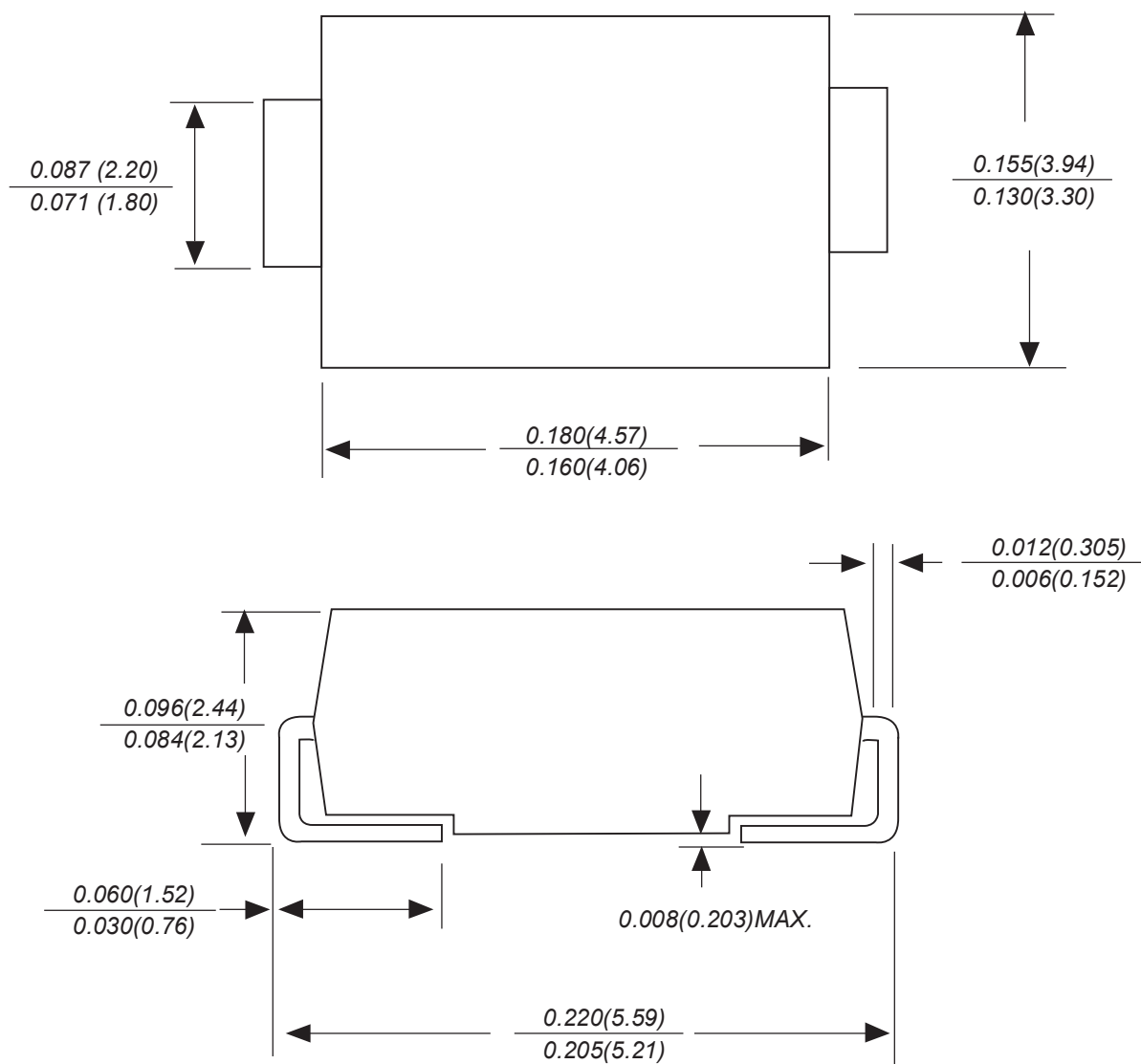
FIG.8 TYPICAL REVERSE CHARACTERISTICS





## Package Outline Dimensions

### SMB(DO-214AA)



*Dimensions in inches and (millimeters)*



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